- Functionally Equivalent to AMD's AM29863
- Power-Up High-Impedance State
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic (NT) 300-mil DIPs

#### description

This 9-bit transceiver is designed for asynchronous two-way communication between data buses. The control-function implementation allows for maximum flexibility in timing.

This device allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic levels at the output-enable (OEAB1, OEAB2, OEBA1, and OEBA2) inputs.

The SN74ALS29863 is characterized for operation from  $0^{\circ}$ C to  $70^{\circ}$ C.

OEBA1       1       24       V <sub>CC</sub> A1       2       23       B1         A2       3       22       B2         A3       4       21       B3         A4       5       20       B4         A5       6       19       B5         A6       7       18       B6	DW OR NT PACKAGE (TOP VIEW)										
A7 [ 8 17 ] B7 A8 [ 9 16 ] B8 A9 [ 10 15 ] B9 OEBA2 [ 11 14 ] OEAB2 GND [ 12 13 ] OEAB1	A1 [ A2 [ A3 [ A4 [ A5 [ A6 [ A7 [ A8 [ A9 [ OEBA2 ]	3 4 5 6 7 8 9 10 11	23 22 21 20 19 18 17 16 15 14	B1 B2 B3 B4 B5 B6 B7 B8 B9 OEAB2							

FUNCTION TABLE										
	INP									
OEAB1	OEAB2	OEBA1	OEBA2	OPERATION						
L	L	L	L	Latch A and B						
L	L	Н	Х							
L	L	Х	Н	A to B						
Н	Х	L	L							
Х	Н	L	L	B to A						
Н	Х	Н	Х							
н	Х	Х	Н	laslation						
Х	Н	Х	Н	isolation						
Х	Н	Н	Х							
н н х	X X H	X X	H H	B to A						

#### FUNCTION TABLE

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

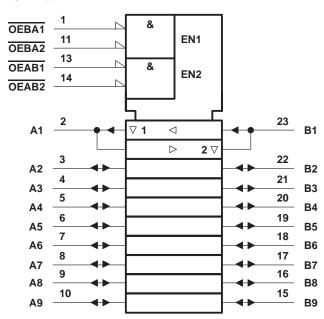


POST OFFICE BOX 655303 • DALLAS, TEXAS 75265 POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

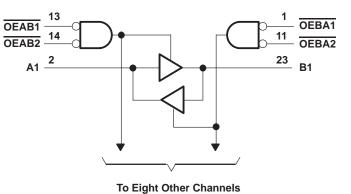
## SN74ALS29863 9-BIT TRANSCEIVER WITH 3-STATE OUTPUTS

SDAS096C - JANUARY 1986 - REVISED JANUARY 1995

#### logic symbol<sup>†</sup>



logic diagram (positive logic)



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>‡</sup>

Supply voltage, V <sub>CC</sub>	
Input voltage, V <sub>I</sub> (all inputs and I/O ports)	5.5 V
Operating free-air temperature range, TA	
Storage temperature range	−65°C to 150°C

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.75	5	5.25	V
VIH	High-level input voltage	2			V
VIL	Low-level input voltage			0.8	V
IOH	High-level output current			-24	mA
IOL	Low-level output current			48	mA
TA	Operating free-air temperature	0		70	°C



## SN74ALS29863 **9-BIT TRANSCEIVER** WITH 3-STATE OUTPUTS

SDAS096C - JANUARY 1986 - REVISED JANUARY 1995

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CO	NDITIONS	MIN	TYP†	MAX	UNIT
VIK		V <sub>CC</sub> = 4.75 V,	lj = – 18 mA			-1.2	V
			I <sub>OH</sub> = – 15 mA	2.4			
Vон		V <sub>CC</sub> = 4.75 V	I <sub>OH</sub> = -24 mA	2	2		V
VOL		V <sub>CC</sub> = 4.75 V,	I <sub>OL</sub> = 48 mA		0.35	0.5	V
II .		V <sub>CC</sub> = 5.25 V,	V <sub>I</sub> = 5.5 V			0.1	mA
	Control inputs					20	
ΙН	A or B ports <sup>‡</sup>	V <sub>CC</sub> = 5.25 V,	V <sub>I</sub> = 2.7 V			20	μA
	Control inputs					-0.1	
ΊL	A or B ports <sup>‡</sup>	V <sub>CC</sub> = 5.25 V,	V <sub>I</sub> = 0.4 V			-0.1	mA
los§		V <sub>CC</sub> = 5.25 V,	$V_{O} = 0$	-75		-250	mA
ICC		V <sub>CC</sub> = 5.25 V			40	65	mA

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. <sup>‡</sup> For I/O ports, the parameters I<sub>IH</sub> and I<sub>IL</sub> include the off-state output current. § Not more than one output should be shorted at a time and duration of the short circuit should not exceed one second.

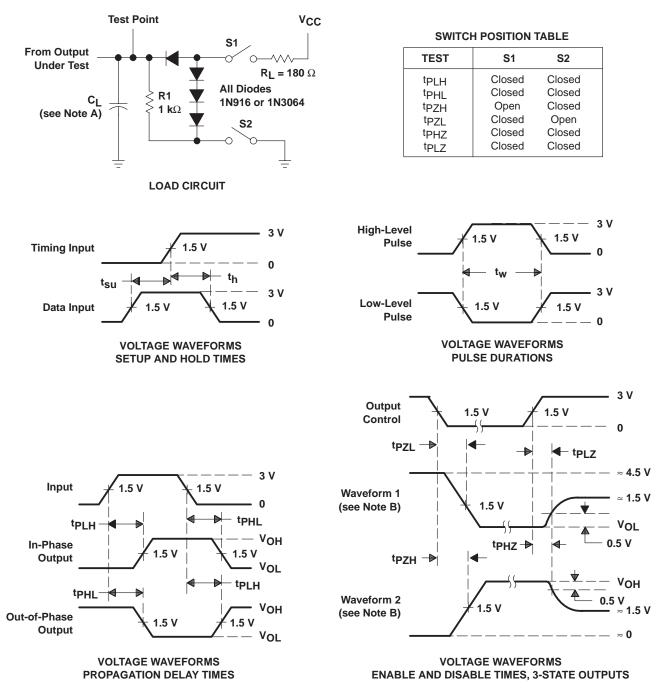
#### switching characteristics (see Figure 1)

DADAMETER	FROM	то	TEAT CONDITIONS	V <sub>CC</sub> = 4.75 V to 5.25 V		
PARAMETER	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN MAX	UNIT	
<sup>t</sup> PLH	A D			15		
<sup>t</sup> PHL	A or B	B or A	C <sub>L</sub> = 300 pF	15	ns	
<sup>t</sup> PLH	A	Dank	0 50 - 5	8		
<sup>t</sup> PHL	A or B	B or A	C <sub>L</sub> = 50 pF	8	ns	
<sup>t</sup> PZH	0545 0554		0 000 5	20		
<sup>t</sup> PZL	OEAB or OEBA	A or B	C <sub>L</sub> = 300 pF	23	ns	
<sup>t</sup> PZH				15	ns	
<sup>t</sup> PZL	OEAB or OEBA	A or B	C <sub>L</sub> = 50 pF	15		
<sup>t</sup> PHZ	0545 0554		0 50 5	17		
<sup>t</sup> PLZ	OEAB or OEBA	A or B	C <sub>L</sub> = 50 pF	12	ns	
<sup>t</sup> PHZ	OEAB or OEBA	A or P	0. E = E	9		
<sup>t</sup> PLZ	UEAD OF UEBA	A or B	C <sub>L</sub> = 5 pF	9	ns	



## SN74ALS29863 9-BIT TRANSCEIVER WITH 3-STATE OUTPUTS

SDAS096C - JANUARY 1986 - REVISED JANUARY 1995



PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z<sub>O</sub> = 50 Ω, t<sub>f</sub> ≤ 2.5 ns, t<sub>f</sub> ≤ 2.5 ns.

Figure 1. Load Circuit and Voltage Waveforms





### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74ALS29863DW	ACTIVE	SOIC	DW	24	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS29863	Samples
SN74ALS29863DWE4	ACTIVE	SOIC	DW	24	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS29863	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



www.ti.com

# PACKAGE OPTION ADDENDUM

13-Aug-2021



www.ti.com

5-Jan-2022

## TUBE



#### \*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
SN74ALS29863DW	DW	SOIC	24	25	506.98	12.7	4826	6.6
SN74ALS29863DWE4	DW	SOIC	24	25	506.98	12.7	4826	6.6

DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013 variation AD.



### IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2022, Texas Instruments Incorporated